

RoHS Compliant Product  
A suffix of "-C" specifies halogen and lead-free

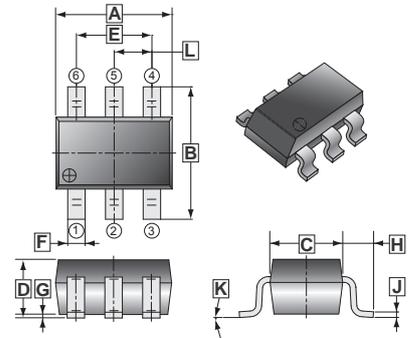
**Key Features:**

- Low  $r_{DS(on)}$  trench technology
- Low thermal impedance
- Fast switching speed

**Typical Applications:**

- Battery Powered Instruments
- Portable Computing
- Mobile Phones
- Fast switch
- GPS Units and Media Players

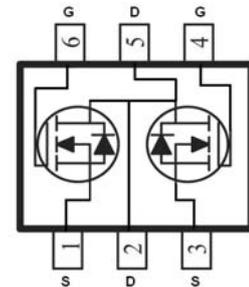
**TSOP-6**



**PACKAGE INFORMATION**

Package	MPQ	Leader Size
TSOP-6	3K	7 inch

REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.70	3.10	G	0	0.10
B	2.60	3.00	H	0.60	REF.
C	1.40	1.80	J	0.12	REF.
D	1.10	MAX.	K	0°	10°
E	1.90	REF.	L	0.95	REF.
F	0.30	0.50			



**ABSOLUTE MAXIMUM RATINGS** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 10$	V
Continuous Drain Current <sup>1</sup>	$I_D$	$T_A = 25^\circ\text{C}$	6
		$T_A = 100^\circ\text{C}$	3.6
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	20	A
Continuous Source Current (Diode Conduction) <sup>1</sup>	$I_S$	1	A
Power Dissipation <sup>1</sup>	$P_D$	$T_A = 25^\circ\text{C}$	0.83
		$T_A = 100^\circ\text{C}$	0.3
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 ~ 150	$^\circ\text{C}$
<b>Thermal Resistance Ratings</b>			
Maximum Junction to Ambient <sup>1</sup>	$R_{\theta JA}$	$t \leq 10$ sec	110
		Steady State	150

Notes

1. Surface Mounted on 1" x 1" FR4 Board.
2. Pulse width limited by maximum junction temperature.

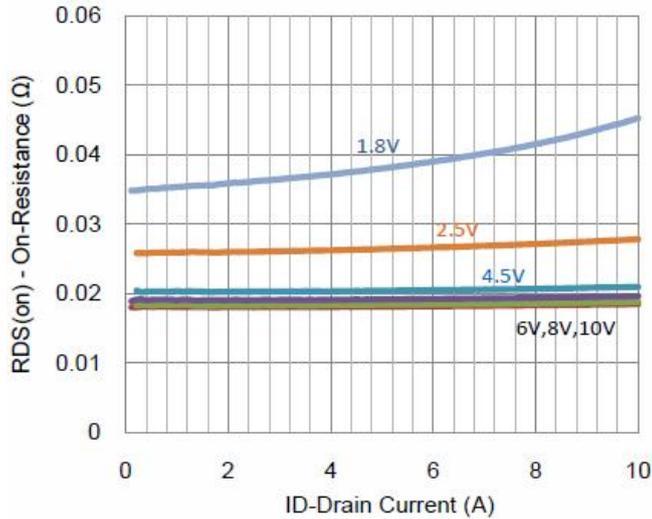
### ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Gate- Source Threshold Voltage	$V_{GS(th)}$	0.5	-	1	V	$V_{DS}=V_{GS}$ , $I_D=250\mu A$
Gate-Body Leakage	$I_{GSS}$	-	-	$\pm 100$	nA	$V_{DS}=0$ , $V_{GS}= \pm 10V$
Zero Gate Voltage Drain Current	$I_{DSS}$	-	-	1	$\mu A$	$V_{DS}=16V$ , $V_{GS}=0 V$
		-	-	30		$V_{DS}=16V$ , $V_{GS}=0 V$ , $T_J= 85^\circ C$
On-State Drain Current	$I_{D(on)}$	10	-	-	A	$V_{DS}=5V$ , $V_{GS}=10V$
Drain-Source On-Resistance	$R_{DS(ON)}$	-	-	24.5	m $\Omega$	$V_{GS}=4.5V$ , $I_D=6A$
		-	-	38		$V_{GS}=2.5V$ , $I_D=5A$
Forward Transconductance	$g_{fs}$	-	10	-	S	$V_{DS}=10V$ , $I_D=6A$
Diode Forward Voltage	$V_{SD}$	-	0.7	-	V	$I_S=1A$ , $V_{GS}=0V$
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	-	12.5	-	nC	$V_{DS}=10V$ , $V_{GS}=4.5V$ , $I_D=5.4A$
Gate-Source Charge	$Q_{gs}$	-	0.7	-		
Gate-Drain Charge	$Q_{gd}$	-	4.3	-		
Turn-on Delay Time	$T_{d(on)}$	-	5	-	nS	$V_{DD}=10V$ , $V_{GEN}=4.5V$ , $R_{GEN}=6\Omega$ , $R_L=10\Omega$ , $I_D=1A$
Rise Time	$T_r$	-	14	-		
Turn-off Delay Time	$T_{d(off)}$	-	30	-		
Fall Time	$T_f$	-	5	-		
Input Capacitance	$C_{iss}$	-	700	-	pF	$V_{DS}=10V$ , $V_{GS}=0$ , $f =1MHz$
Output Capacitance	$C_{oss}$	-	125	-		
Reverse Transfer Capacitance	$C_{rss}$	-	110	-		

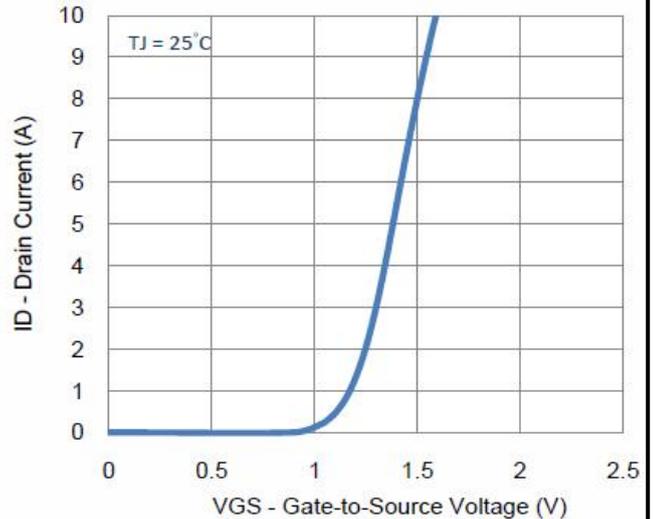
**Notes**

1. Pulse test :  $PW \leq 300\mu s$  duty cycle  $\leq 2\%$ .
2. Guaranteed by design, not subject to production testing.

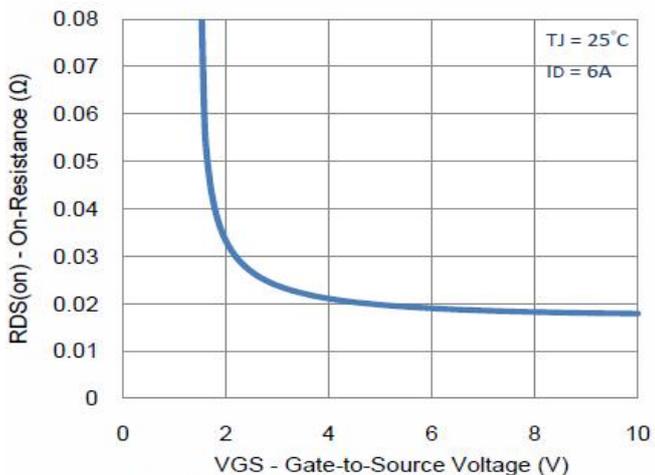
**Electrical Characteristics**



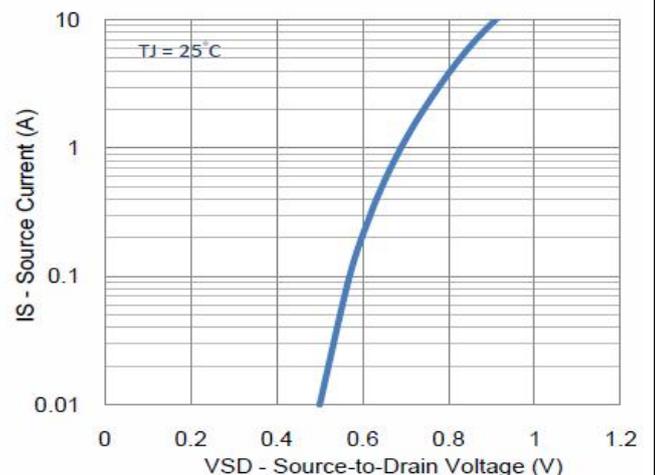
**1. On-Resistance vs. Drain Current**



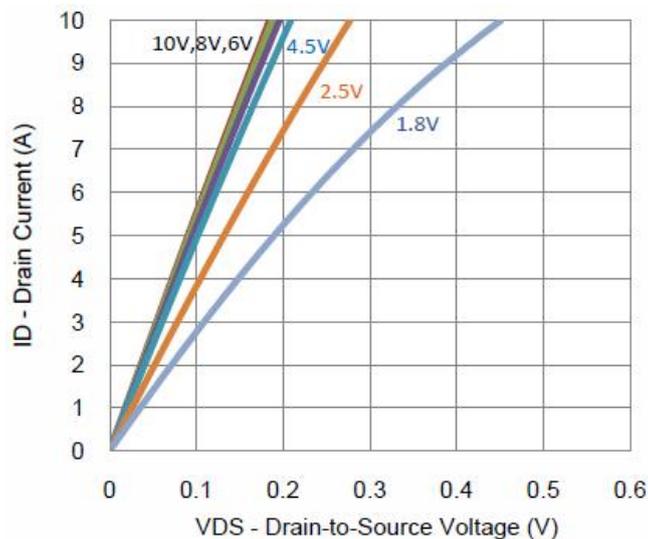
**2. Transfer Characteristics**



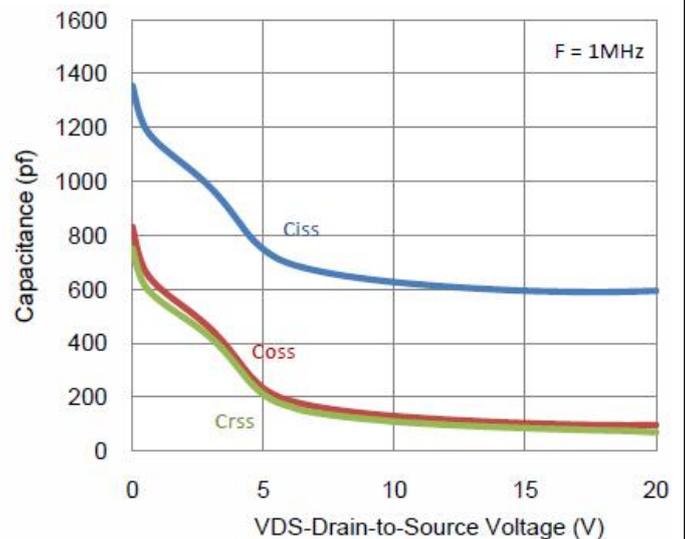
**3. On-Resistance vs. Gate-to-Source Voltage**



**4. Drain-to-Source Forward Voltage**



**5. Output Characteristics**



**6. Capacitance**

**Typical Electrical Characteristics**

